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#### **FEATURES**

- Member of the Texas Instruments Widebus™
   Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 4.8 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   >2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- All Outputs Have Equivalent 26- $\Omega$  Series Resistors, So No External Resistors Are Required
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

# DGG, DGV, OR DL PACKAGE (TOP VIEW)

|                   | $\overline{}$ | _                  |
|-------------------|---------------|--------------------|
| 1DIR[             | 1 U           | 48 1 <del>0E</del> |
| 1B1 [             | 2             | 47 🛮 1A1           |
| 1B2 [             | 3             | 46 1A2             |
| GND [             | 4             | 45 GND             |
| 1B3 [             | 5             | 44 🛮 1A3           |
| 1B4 [             | 6             | 43 1A4             |
| V <sub>CC</sub> [ | 7             | 42 V <sub>CC</sub> |
| 1B5 [             | 8             | 41 🛮 1A5           |
| 1B6 [             | 9             | 40 <b>]</b> 1A6    |
| GND[              | 10            | 39 GND             |
| 1B7 [             | 11            | 38 🛮 1A7           |
| 1B8 [             | 12            | 37 🛮 1A8           |
| 2B1 [             | 13            | 36 2A1             |
| 2B2 [             | 14            | 35 2A2             |
| GND[              | 15            | 34 ] GND           |
| 2B3 [             | 16            | 33 2A3             |
| 2B4 [             | 17            | 32 2A4             |
| V <sub>CC</sub> [ | 18            | 31 V <sub>CC</sub> |
| 2B5 [             | 19            | 30 2A5             |
| 2B6 [             | 20            | 29 2A6             |
| GND [             | 21            | 28 GND             |
| 2B7 [             | 22            | 27 2A7             |
| 2B8 [             | 23            | 26 2A8             |
| 2DIR [            | 24            | 25 2 <del>0E</del> |
|                   |               |                    |

#### **DESCRIPTION/ORDERING INFORMATION**

This 16-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCHR16245A is designed for asynchronous communication between data buses. The control-function implementation minimizes external-timing requirements.

#### ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE               | (1)           | ORDERABLE PART NUMBER | TOP-SIDE MARKING   |
|----------------|-----------------------|---------------|-----------------------|--|
|                | FBGA – GRD            | Tone and real | 74LVCHR16245AGRDR     | I P245A  |
|                | FBGA – ZRD (Pb-free)  | Tape and reel | 74LVCHR16245AZRDR     | LK245A   |
|                | SSOP – DL             | Tone and real | SN74LVCHR16245ALR     | LVCUD46245A  |
|                | 330P - DL             | Tape and reel | 74LVCHR16245ALRG4     | EVCHR 16245A   |
|                | TSSOP – DGG           | Tana and real | SN74LVCHR16245AGR     | LVCHP16245A  |
| –40°C to 85°C  | 1330F – DGG           | Tape and reel | 74LVCHR16245AGRG4     | R16245AGRDR R16245AZRDR CHR16245ALR R16245ALRG4 CHR16245AGR CHR16245AGR R16245AGRG4 CHR16245AVR CHR16245AVR R16245AVRE4 CHR16245AKR LDR245A LR245A |
| -40 C to 65 C  | TVSOP – DGV           | Tape and reel | SN74LVCHR16245AVR     | LDB245A  |
|                | TVSOP – DGV           | rape and reer | 74LVCHR16245AVRE4     | LDR243A  |
|                | VFBGA – GQL           | Tone and real | SN74LVCHR16245AKR     | 1 P245A  |
|                | VFBGA – ZQL (Pb-free) | Tape and reel | 74LVCHR16245AZQLR     | LR243A   |

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines areavailable at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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#### **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can disable the device so that the buses are effectively isolated.

All outputs, which are designed to sink up to 12 mA, include equivalent 26- $\Omega$  series resistors to reduce overshoot and undershoot.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended. The bus-hold circuitry is part of the input circuit and is not disabled by  $\overline{\sf OE}$  or DIR.

# GQL OR ZQL PACKAGE (TOP VIEW)

|   | 1 2 3 4 5 6 |
|---|-------------|
| Α | 000000      |
| В | 000000      |
| С | 000000      |
| D | 000000      |
| Е | 00 00       |
| F | 00 00       |
| G | 000000      |
| н | 000000      |
| J | 000000      |
| K | [           |

# TERMINAL ASSIGNMENTS<sup>(1)</sup> (56-Ball GQL/ZQL Package)

|   | (00 2411 0 4 2 2 2 4 2 1 4 0 1 4 9 0 ) |     |                 |                 |     |                 |  |  |  |  |
|---|--|-----|-----------------|-----------------|-----|-----------------|--|--|--|--|
|   | 1                                      | 2   | 3               | 4               | 5   | 6               |  |  |  |  |
| Α | 1DIR                                   | NC  | NC              | NC              | NC  | 1 <del>OE</del> |  |  |  |  |
| В | 1B2                                    | 1B1 | GND             | GND             | 1A1 | 1A2             |  |  |  |  |
| С | 1B4                                    | 1B3 | V <sub>CC</sub> | V <sub>CC</sub> | 1A3 | 1A4             |  |  |  |  |
| D | 1B6                                    | 1B5 | GND             | GND             | 1A5 | 1A6             |  |  |  |  |
| Е | 1B8                                    | 1B7 |                 |                 | 1A7 | 1A8             |  |  |  |  |
| F | 2B1                                    | 2B2 |                 |                 | 2A2 | 2A1             |  |  |  |  |
|   | G2B3                                   | 2B4 | GND             | GND             | 2A4 | 2A3             |  |  |  |  |
| Н | 2B5                                    | 2B6 | V <sub>CC</sub> | V <sub>CC</sub> | 2A6 | 2A5             |  |  |  |  |
| J | 2B7                                    | 2B8 | GND             | GND             | 2A8 | 2A7             |  |  |  |  |
| K | 2DIR                                   | NC  | NC              | NC              | NC  | 2 <del>OE</del> |  |  |  |  |

(1) NC - No internal connection

#### GRD OR ZRD PACKAGE (TOP VIEW)

|   |           | 1          | 2          | 3          | 4          | 5          | 6          | _ |
|---|-----------|------------|------------|------------|------------|------------|------------|---|
| Α | $\bigcap$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | _ |
| В |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| С |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| D |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| Ε |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| F |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| G |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| Н |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
| J |           | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |   |
|   | \         |            |            |            |            |            |            |   |

# TERMINAL ASSIGNMENTS<sup>(1)</sup> (54-Ball GRD/ZRD Package)

|   | 1   | 2   | 3               | 4               | 5   | 6   |
|---|-----|-----|-----------------|-----------------|-----|-----|
| Α | 1B1 | NC  | 1DIR            | 1 <del>OE</del> | NC  | 1A1 |
| В | 1B3 | 1B2 | NC              | NC              | 1A2 | 1A3 |
| С | 1B5 | 1B4 | V <sub>CC</sub> | V <sub>CC</sub> | 1A4 | 1A5 |
| D | 1B7 | 1B6 | GND             | GND             | 1A6 | 1A7 |
| E | 2B1 | 1B8 | GND             | GND             | 1A8 | 2A1 |
| F | 2B3 | 2B2 | GND             | GND             | 2A2 | 2A3 |
| G | 2B5 | 2B4 | V <sub>CC</sub> | V <sub>CC</sub> | 2A4 | 2A5 |
| Н | 2B7 | 2B6 | NC              | NC              | 2A6 | 2A7 |
| J | 2B8 | NC  | 2DIR            | 2 <del>OE</del> | NC  | 2A8 |

(1) NC - No internal connection

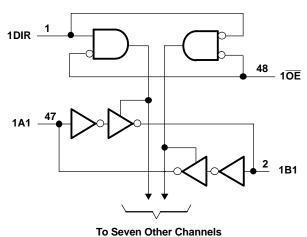


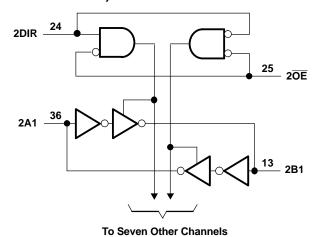
# FUNCTION TABLE<sup>(1)</sup> (EACH 8-BIT SECTION)

| CONTRO | L INPUTS | OUTPUT C | IRCUITS | OPERATION       |
|--------|----------|----------|---------|-----------------|
| ŌĒ     | DIR      | A PORT   | B PORT  | OPERATION       |
| L      | L        | Enabled  | Hi-Z    | B data to A bus |
| L      | Н        | Hi-Z     | Enabled | A data to B bus |
| Н      | Χ        | Hi-Z     | Hi-Z    | Isolation       |

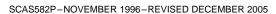
(1) Input circuits of the data I/Os always are active.

#### **LOGIC DIAGRAM (POSITIVE LOGIC)**





## SN74LVCHR16245A 16-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS





### **Absolute Maximum Ratings**(1)

over operating free-air temperature range (unless otherwise noted)

|                  |   |  | MIN  | MAX                   | UNIT |
|------------------|---|--|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range                                  |  | -0.5 | 6.5                   | V    |
| VI               | Input voltage range <sup>(2)</sup>                    | Input voltage range (2)                          |      |                       | V    |
| Vo               | Voltage range applied to any output in the h          | nigh-impedance or power-off state <sup>(2)</sup> | -0.5 | 6.5                   | V    |
| Vo               | Voltage range applied to any output in the h          | nigh or low state <sup>(2)(3)</sup>              | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                                   | V <sub>I</sub> < 0                               |      | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current                                  | V <sub>O</sub> < 0                               |      | -50                   | mA   |
| Io               | Continuous output current                             | Continuous output current                        |      | ±50                   | mA   |
|                  | Continuous current through each V <sub>CC</sub> or GN | ND   |      | ±100                  | mA   |
|                  |   | DGG package                                      |      | 70                    |      |
|                  |   | DGV package                                      |      | 58                    |      |
| $\theta_{JA}$    | Package thermal impedance (4)                         | DL package                                       |      | 63                    | °C/W |
|                  |   | GQL/ZQL package                                  |      | 42                    |      |
|                  |   | GRD/ZRD package                                  |      | 36                    |      |
| T <sub>stg</sub> | Storage temperature range                             |  | -65  | 150                   | °C   |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    |   | MIN                    | MAX                    | UNIT |  |
|-----------------|------------------------------------|---|------------------------|------------------------|------|--|
| V               | Cumply valtage                     | Operating   | 1.65                   | 3.6                    | V    |  |
| V <sub>CC</sub> | Supply voltage                     | Data retention only   | 1.5                    |                        | V    |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V                          | 0.65 × V <sub>CC</sub> |                        |      |  |
| $V_{IH}$        | High-level input voltage           | el input voltage $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |                        |                        | V    |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V                            | 2                      |                        |      |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V                          |                        | 0.35 × V <sub>CC</sub> |      |  |
| $V_{IL}$        | Low-level input voltage            | V <sub>CC</sub> = 2.3 V to 2.7 V                            |                        | 0.7                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V                            |                        | 0.8                    |      |  |
| VI              | Input voltage                      | ,   | 0                      | 5.5                    | V    |  |
| V <sub>O</sub>  | Outrot valtage                     | High or low state   | 0                      | $V_{CC}$               | V    |  |
|                 | Output voltage                     | 3-state   | 0                      | 5.5                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V                                    |                        | -2                     |      |  |
|                 | High lavel autout august           | V <sub>CC</sub> = 2.3 V                                     | -4                     |                        | A    |  |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2.7 V                                     |                        | -8                     | mA   |  |
|                 |                                    | V <sub>CC</sub> = 3 V                                       |                        | -12                    |      |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V                                    |                        | 2                      |      |  |
|                 | Law law Law to the standard and    | V <sub>CC</sub> = 2.3 V                                     |                        | 4                      | ^    |  |
| l <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 2.7 V                                     |                        | 8                      | mA   |  |
|                 |                                    | V <sub>CC</sub> = 3 V                                       |                        |                        |      |  |
| Δt/Δν           | Input transition rise or fall rate | ,   |                        | 10                     | ns/V |  |
| T <sub>A</sub>  | Operating free-air temperature     |   | -40                    | 85                     | °C   |  |

<sup>(1)</sup> All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

<sup>(2)</sup> The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>3)</sup> The value of V<sub>CC</sub> is provided in the recommended operating conditions table.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PA                             | RAMETER        | TEST CONDITIONS   |                    | V <sub>cc</sub> | MIN                   | TYP <sup>(1)</sup> MAX | UNIT |  |
|--------------------------------|----------------|---|--------------------|-----------------|-----------------------|------------------------|------|--|
|                                |                | I <sub>OH</sub> = -100 μA                                       |                    | 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2 |                        |      |  |
|                                |                | $I_{OH} = -2 \text{ mA}$  |                    | 1.65 V          | 1.2                   |                        |      |  |
|                                |                | 1 4 50  |                    | 2.3 V           | 1.7                   |                        |      |  |
| $V_{OH}$                       |                | $I_{OH} = -4 \text{ mA}$  |                    | 2.7 V           | 2.2                   |                        | V    |  |
|                                |                | I <sub>OH</sub> = -6 mA   | 3 V                | 2.4             |                       |                        |      |  |
|                                |                | $I_{OH} = -8 \text{ mA}$  |                    | 2.7 V           | 2                     |                        |      |  |
|                                |                | I <sub>OH</sub> = -12 mA  |                    | 3 V             | 2                     |                        |      |  |
|                                |                | I <sub>OL</sub> = 100 μA  |                    | 1.65 V to 3.6 V |                       | 0.2                    |      |  |
| V <sub>OL</sub>                |                | I <sub>OL</sub> = 2 mA  | 1.65 V             |                 | 0.45                  |                        |      |  |
|                                |                | 1 4 50  |                    | 2.3 V           |                       | 0.7                    |      |  |
|                                |                | $I_{OL} = 4 \text{ mA}$   | 2.7 V              |                 | 0.4                   | V                      |      |  |
|                                |                | I <sub>OL</sub> = 6 mA  | 3 V                |                 | 0.55                  |                        |      |  |
|                                |                | I <sub>OL</sub> = 8 mA  | 2.7 V              |                 | 0.6                   |                        |      |  |
|                                |                | I <sub>OL</sub> = 12 mA   | 3 V                |                 | 0.8                   |                        |      |  |
| l <sub>l</sub>                 | Control inputs | V <sub>I</sub> = 0 to 5.5 V                                     |                    | 3.6 V           |                       | ±5                     | μΑ   |  |
|                                |                | V <sub>I</sub> = 0.58 V   | 4.05.1/            | (2)             | (2)                   |                        |      |  |
|                                |                | V <sub>I</sub> = 1.07 V   | 1.65 V             | (2)             |                       |                        |      |  |
|                                |                | V <sub>I</sub> = 0.7 V  |                    | 227             | 45                    |                        |      |  |
| I <sub>I(hold)</sub>           | A or B port    | V <sub>I</sub> = 1.7 V  |                    | 2.3 V           | -45                   |                        | μΑ   |  |
|                                |                | V <sub>I</sub> = 0.8 V  |                    | 2.1/            | 75                    |                        |      |  |
|                                |                | V <sub>I</sub> = 2 V  |                    | 3 V             | -75                   |                        |      |  |
|                                |                | V <sub>I</sub> = 0 to 3.6 V <sup>(3)</sup>                      |                    | 3.6 V           |                       | ±500                   |      |  |
| l <sub>off</sub>               | •              | $V_I$ or $V_O = 5.5 \text{ V}$                                  |                    | 0               |                       | ±10                    | μΑ   |  |
| I <sub>OZ</sub> <sup>(4)</sup> |                | $V_O = 0 \text{ V or } (V_{CC} \text{ to } 5.5 \text{ V})$      |                    | 2.3 V to 3.6 V  |                       | ±5                     | μΑ   |  |
| I <sub>cc</sub>                |                | V <sub>I</sub> = V <sub>CC</sub> or GND                         | 1 0                | 261/            |                       | 20                     | ^    |  |
|                                |                | $3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{(5)}$ | I <sub>O</sub> = 0 | 3.6 V           |                       | 20                     | μΑ   |  |
| Δl <sub>CC</sub>               |                | One input at V <sub>CC</sub> – 0.6 V, Other inputs              | 2.7 V to 3.6 V     |                 | 500                   | μΑ                     |      |  |
| C <sub>i</sub>                 | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                         |                    | 3.3 V           |                       | 3                      | pF   |  |
| C <sub>io</sub>                | A or B port    | V <sub>O</sub> = V <sub>CC</sub> or GND                         |                    | 3.3 V           |                       | 12                     | pF   |  |

<sup>(1)</sup> All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.
(2) This information was not available at the time of publication.

This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

For the total leakage current in an I/O port, please consult the  $I_{I(hold)}$  specification for the input voltage condition 0 V <  $V_I$  <  $V_{CC}$ , and the  $I_{OZ}$  specification for the input voltage conditions  $V_I$  = 0 V or  $V_I$  =  $V_{CC}$  to 5.5 V. The bus-hold current, at input voltages greater than  $V_{CC}$ , is negligible.

This applies in the disabled state only.

## SN74LVCHR16245A 16-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS582P-NOVEMBER 1996-REVISED DECEMBER 2005



#### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER |                  | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> =<br>± 0.1 |      | V <sub>CC</sub> = ± 0.2 |      | V <sub>CC</sub> = | 2.7 V | V <sub>CC</sub> = :<br>± 0.3 | 3.3 V<br>3 V | UNIT |
|-----------|------------------|-----------------|----------------|----------------------------|------|-------------------------|------|-------------------|-------|------------------------------|--------------|------|
|           |                  | (INFOT)         | (001701)       | MIN                        | MAX  | MIN                     | MAX  | MIN               | MAX   | MIN                          | MAX          |      |
|           | t <sub>pd</sub>  | A or B          | B or A         | 1                          | 12.5 | 1                       | 9.5  | 1                 | 5.7   | 1.5                          | 4.8          | ns   |
|           | t <sub>en</sub>  | ŌĒ              | A or B         | 1                          | 15.8 | 1                       | 12.2 | 1                 | 7.9   | 1.5                          | 6.3          | ns   |
|           | t <sub>dis</sub> | ŌĒ              | A or B         | 1                          | 19.2 | 1                       | 11.9 | 1                 | 8.3   | 2.2                          | 7.4          | ns   |

## **Operating Characteristics**

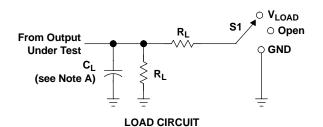
 $T_A = 25^{\circ}C$ 

|                 | PARAMETER                     |                  | TEST<br>CONDITIONS | V <sub>CC</sub> = 1.8 V<br>TYP | V <sub>CC</sub> = 2.5 V<br>TYP | V <sub>CC</sub> = 3.3 V<br>TYP | UNIT |
|-----------------|-------------------------------|------------------|--------------------|--------------------------------|--------------------------------|--------------------------------|------|
| C               | Power dissipation capacitance | Outputs enabled  | f = 10 MHz         | (1)                            | (1)                            | 39                             | рF   |
| C <sub>pd</sub> | per transceiver               | Outputs disabled | 1 = 10 10172       | (1)                            | (1)                            | 4                              | рΓ   |

(1) This information was not available at the time of publication.

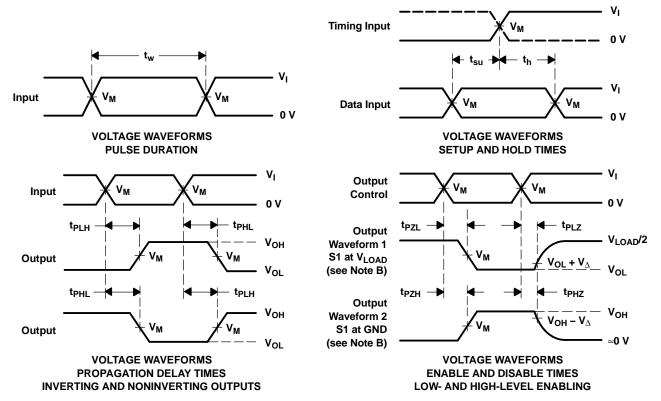


#### PARAMETER MEASUREMENT INFORMATION



| TEST                               | S1                |
|------------------------------------|-------------------|
| t <sub>PLH</sub> /t <sub>PHL</sub> | Open              |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>LOAD</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

**INPUT** V<sub>CC</sub>  $V_{M}$ **V<sub>LOAD</sub>**  $C_L$  $R_L$  $V_{\Delta}$ ٧ı t<sub>r</sub>/t<sub>f</sub> 1.8 V  $\pm$  0.15 V ≤2 ns 30 pF 0.15 V Vcc V<sub>CC</sub>/2 Vcc 1  $k\Omega$  $\nu_{\text{CC}}$  $v_{cc}$ **500** Ω  $\textbf{2.5 V} \pm \textbf{0.2 V}$ ≤2 ns V<sub>CC</sub>/2 30 pF 0.15 V 2.7 V 2.7 V ≤2.5 ns 1.5 V 6 V 50 pF 500  $\Omega$ 0.3 V 2.7 V 6 V ≤2.5 ns 1.5 V **500** Ω 3.3 V  $\pm$  0.3 V 50 pF 0.3 V



NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \ \Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





10-Jun-2014

#### PACKAGING INFORMATION

| Orderable Device  | Status   | Package Type               | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)            | Samples |
|-------------------|----------|----------------------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|---------------------------------|---------|
| 74LVCHR16245AGRDR | OBSOLETE | BGA<br>MICROSTAR<br>JUNIOR | GRD                | 54   |                | TBD                        | Call TI          | Call TI            | -40 to 85    |                                 |         |
| 74LVCHR16245AGRG4 | ACTIVE   | TSSOP                      | DGG                | 48   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | LVCHR16245A                     | Samples |
| 74LVCHR16245ALRG4 | ACTIVE   | SSOP                       | DL                 | 48   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | (LVCHR162245A ~<br>LVCHR16245A) | Samples |
| 74LVCHR16245AZQLR | ACTIVE   | BGA<br>MICROSTAR<br>JUNIOR | ZQL                | 56   | 1000           | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM | -40 to 85    | LR245A                          | Samples |
| 74LVCHR16245AZRDR | ACTIVE   | BGA<br>MICROSTAR<br>JUNIOR | ZRD                | 54   | 1000           | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM | -40 to 85    | LR245A                          | Samples |
| SN74LVCHR16245AGR | ACTIVE   | TSSOP                      | DGG                | 48   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | LVCHR16245A                     | Samples |
| SN74LVCHR16245AKR | OBSOLETE | BGA<br>MICROSTAR<br>JUNIOR | GQL                | 56   |                | TBD                        | Call TI          | Call TI            | -40 to 85    | LR245A                          |         |
| SN74LVCHR16245ALR | ACTIVE   | SSOP                       | DL                 | 48   | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | (LVCHR162245A ~<br>LVCHR16245A) | Samples |
| SN74LVCHR16245AVR | ACTIVE   | TVSOP                      | DGV                | 48   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | LDR245A                         | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



### **PACKAGE OPTION ADDENDUM**

10-Jun-2014

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

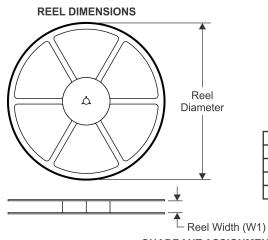
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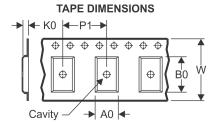
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## PACKAGE MATERIALS INFORMATION

www.ti.com 23-Sep-2013

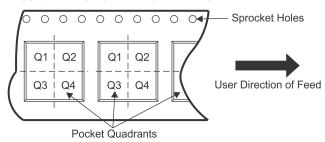
#### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

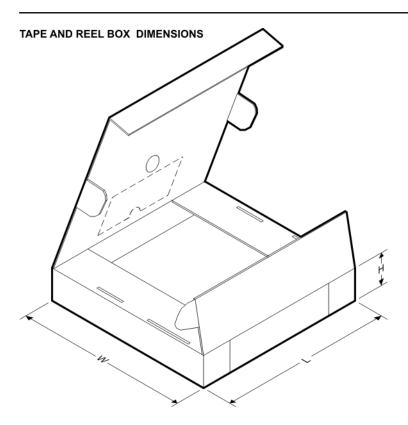
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device            | Package<br>Type                  | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|----------------------------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| 74LVCHR16245AZQLR | BGA MI<br>CROSTA<br>R JUNI<br>OR | ZQL                | 56 | 1000 | 330.0                    | 16.4                     | 4.8        | 7.3        | 1.5        | 8.0        | 16.0      | Q1               |
| 74LVCHR16245AZRDR | BGA MI<br>CROSTA<br>R JUNI<br>OR | ZRD                | 54 | 1000 | 330.0                    | 16.4                     | 5.8        | 8.3        | 1.55       | 8.0        | 16.0      | Q1               |
| SN74LVCHR16245AGR | TSSOP                            | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 15.8       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74LVCHR16245ALR | SSOP                             | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |
| SN74LVCHR16245AVR | TVSOP                            | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |

www.ti.com 23-Sep-2013

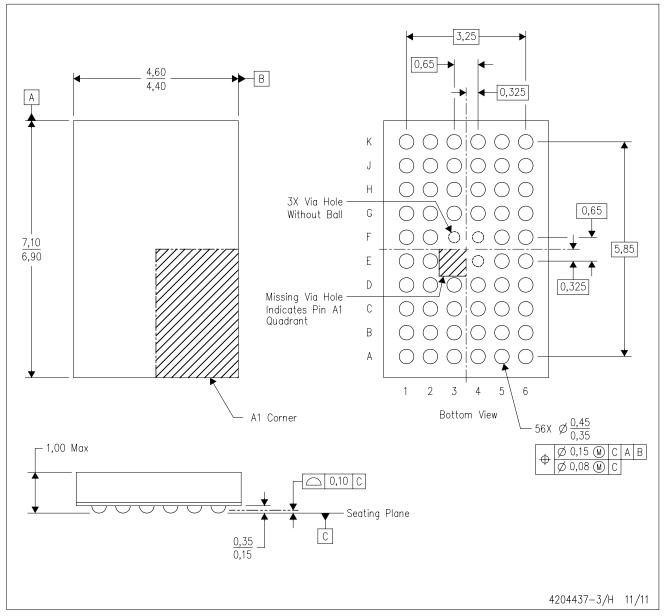


\*All dimensions are nominal

| All difficusions are norminal |                         |                 |      |      |             |            |             |
|-------------------------------|-------------------------|-----------------|------|------|-------------|------------|-------------|
| Device                        | Package Type            | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| 74LVCHR16245AZQLR             | BGA MICROSTAR<br>JUNIOR | ZQL             | 56   | 1000 | 336.6       | 336.6      | 28.6        |
| 74LVCHR16245AZRDR             | BGA MICROSTAR<br>JUNIOR | ZRD             | 54   | 1000 | 336.6       | 336.6      | 28.6        |
| SN74LVCHR16245AGR             | TSSOP                   | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LVCHR16245ALR             | SSOP                    | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |
| SN74LVCHR16245AVR             | TVSOP                   | DGV             | 48   | 2000 | 367.0       | 367.0      | 38.0        |

## ZQL (R-PBGA-N56)

#### PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

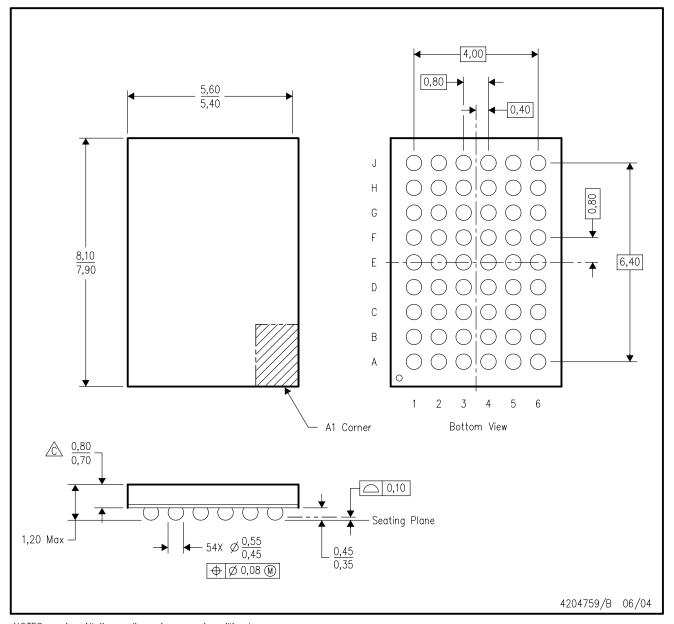
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is Pb-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

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# GRD (R-PBGA-N54)

## PLASTIC BALL GRID ARRAY



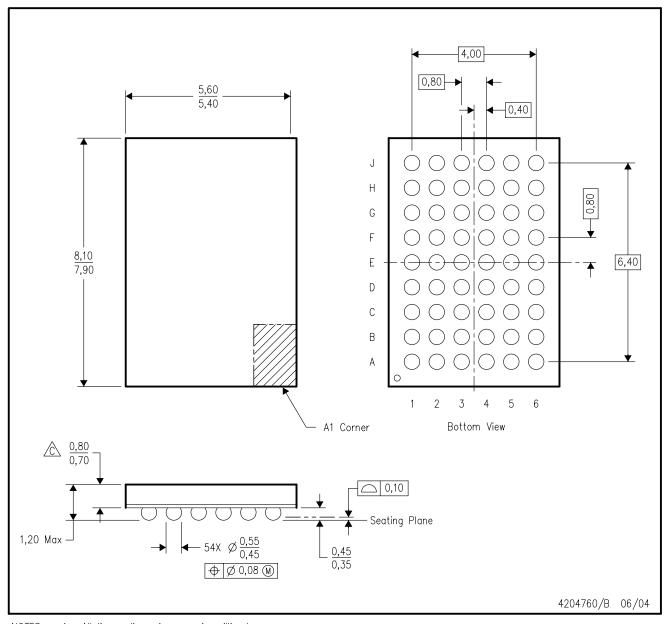
 $\hbox{NOTES:} \quad \hbox{A. All linear dimensions are in millimeters.}$ 

- B. This drawing is subject to change without notice.
- Falls within JEDEC MO-205 variation DD.
- D. This package is tin-lead (SnPb). Refer to the 54 ZRD package (drawing 4204760) for lead-free.



# ZRD (R-PBGA-N54)

## PLASTIC BALL GRID ARRAY



 $\hbox{NOTES:} \quad \hbox{A. All linear dimensions are in millimeters.}$ 

- B. This drawing is subject to change without notice.
- Falls within JEDEC MO-205 variation DD.
- D. This package is lead—free. Refer to the 54 GRD package (drawing 4204759) for tin—lead (SnPb).



#### DGV (R-PDSO-G\*\*)

#### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

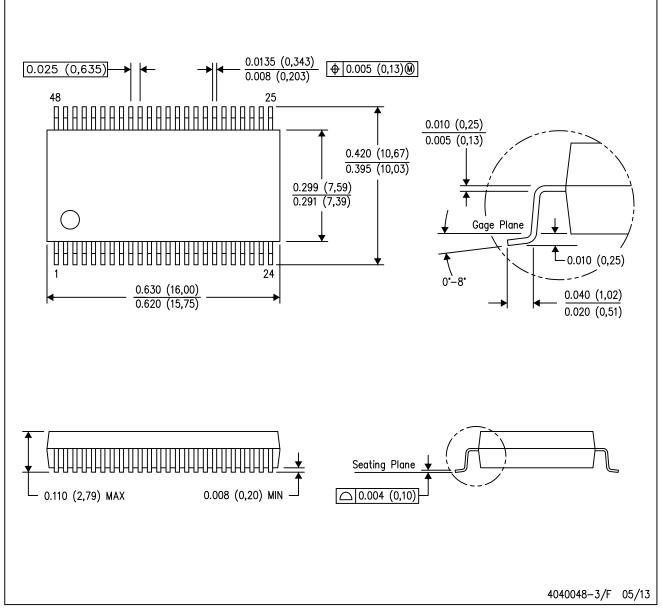
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

## DL (R-PDSO-G48)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

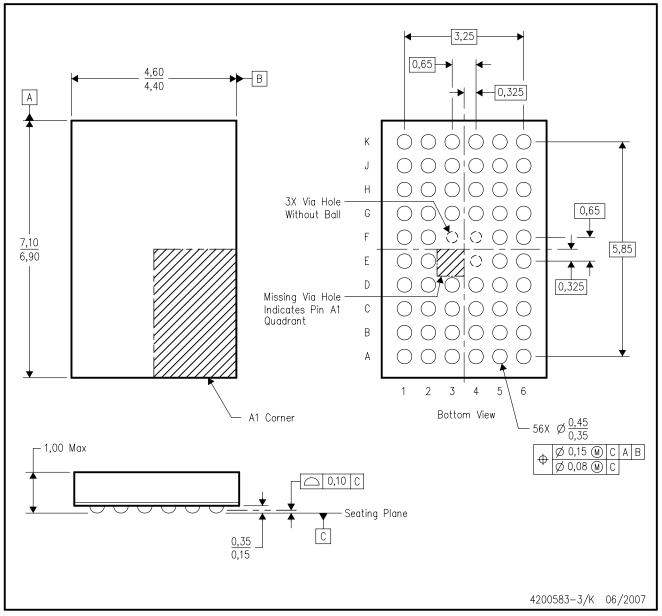
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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# GQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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